

Precision Thick Film Chip Resistors

ERJ G : 01005, 0201

ERJ R : 0201, 0402, 0603, 0805

ERJ E : 0603, 0805, 1206,
1210, 1812, 2010, 2512

Type: **ERJ XG, 1G**

ERJ 1R, 2R, 3R, 6R

ERJ 3E, 6E, 8E, 14, 12, 1T



■ Features

- Small size and lightweight
- High reliability
Metal glaze thick film resistive element and three layers of electrodes
- Compatible with placement machines
Taping packaging available
- Suitable for both reflow and flow soldering

● Low Resistance Tolerance

ERJXG, 1G, 2R, 3E, 6E, 8E, 14, 12, 1T Series.....±1 %

ERJ1R, 2R, 3R, 6R Series ±0.5 %

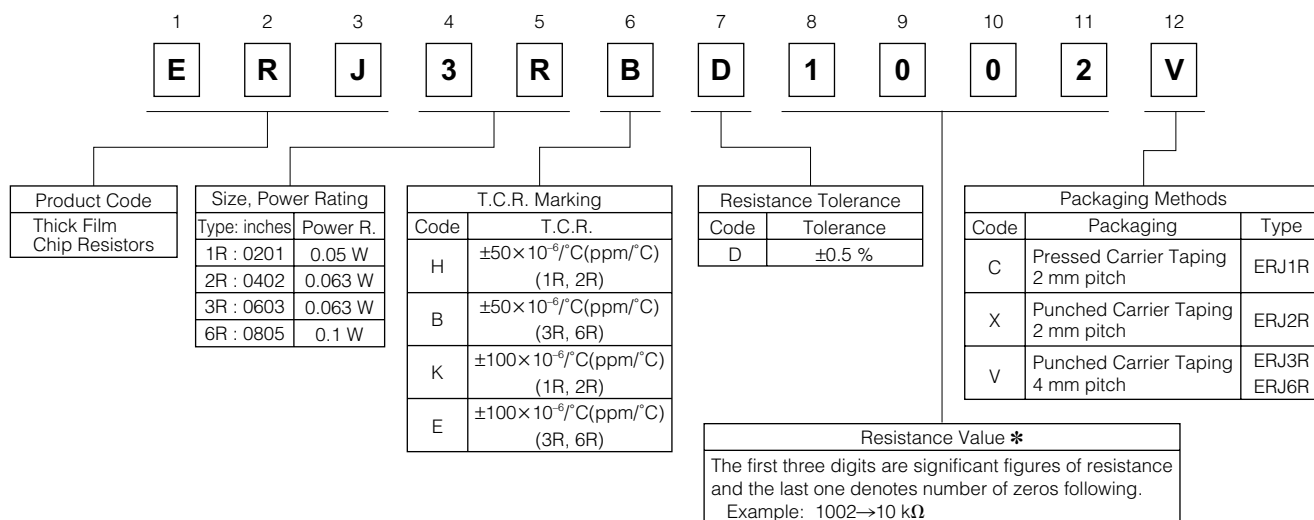
● Reference Standards

IEC 60115-8, JIS C 5201-8

■ Explanation of Part Numbers

* For existing customers, we continue to use the three-digit resistance code in the part numbers.

● ERJ1R, 2R, 3R, 6R Series, ±0.5 % type



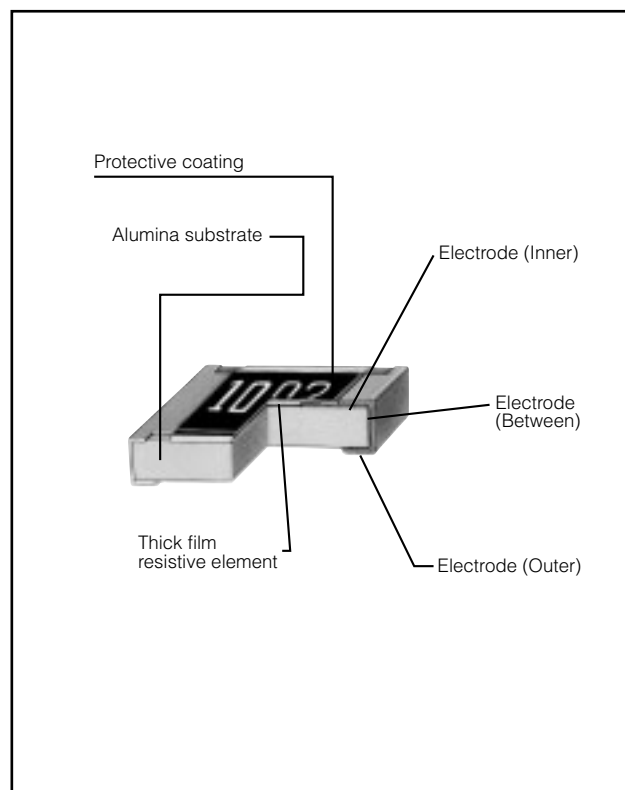
● ERJXG, 1G Series, $\pm 1\%$ type

1	2	3	4	5	6	7	8	9	10	11	12
E	R	J	1	G	E	F	1	0	0	2	C
Product Code Thick Film Chip Resistors	Size, Power Rating Type : inches Power R. XGN : 01005 0.031 W 1GE : 0201 0.050 W		Resistance Tolerance Code Tolerance F $\pm 1\%$		Resistance Value The first three digits are significant figures of resistance and the last one denotes number of zeros			Packaging Methods Code Packaging Type Y Pressed Carrier Taping 2 mm pitch, 20000 pcs. ERJXGN C Pressed Carrier Taping 2 mm pitch, 15000 pcs. ERJ1GE			

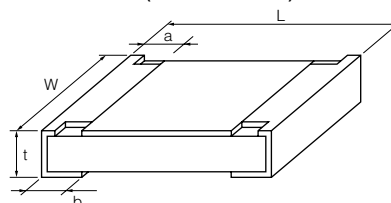
● ERJ2R, 3E, 6E, 8E, 14, 12, 1T Series, $\pm 1\%$ type

1	2	3	4	5	6	7	8	9	10	11	12		
E	R	J	8	E	N	F	1	0	0	2	V		
Product Code Thick Film Chip Resistors			Size, Power Rating Type: inches Power R. 2R : 0402 0.1 W 3E : 0603 0.1 W 6E : 0805 0.125 W 8E : 1206 0.25 W 14 : 1210 0.5 W 12 : 1812 0.75 W 12 : 2010 0.75 W 1T : 2512 1 W			Marking Code Marking K No marking (2R, 3E) N 4 digit marking (6E, 8E, 14, 12, 1T) S 4 digit marking [12(2010 inches)]			Resistance Tolerance Code Tolerance F ±1 %		Packaging Methods Code Packaging Type X Punched Carrier Taping 2 mm pitch ERJ2R V Punched Carrier Taping 4 mm pitch ERJ3E ERJ6E ERJ8E U Embossed Carrier Taping 4 mm pitch ERJ14 ERJ12 ERJ1T		
Resistance Value *													
The first three digits are significant figures of resistance and the 4th one denotes number of zeros following.													

■ Construction



■ Dimensions in mm (not to scale)



Type (inches)	Dimensions (mm)					Mass (Weight) [g/1000 pcs.]
	L	W	a	b	t	
ERJXG (01005)	0.40 ± 0.02	0.20 ± 0.02	0.10 ± 0.03	0.10 ± 0.03	0.13 ± 0.02	0.04
ERJ1G, 1R (0201)	0.60 ± 0.03	0.30 ± 0.03	0.10 ± 0.05	0.15 ± 0.05	0.23 ± 0.03	0.15
ERJ2R□ (0402)	1.00 ± 0.05	0.50 ± 0.05	0.20 ± 0.10	0.25 ± 0.05	0.35 ± 0.05	0.8
ERJ3R□ (0603)	1.60 ± 0.15	0.80 ± 0.15	0.30 ± 0.20	0.30 ± 0.15	0.45 ± 0.10	2
ERJ6R□ (0805)	2.00 ± 0.20	1.25 ± 0.10	0.40 ± 0.20	0.40 ± 0.20	0.60 ± 0.10	4
ERJ3EK (0603)	1.60 ± 0.15	0.80 ± 0.15	0.30 ± 0.20	0.30 ± 0.15	0.45 ± 0.10	2
ERJ6EN (0805)	2.00 ± 0.20	1.25 ± 0.10	0.40 ± 0.20	0.40 ± 0.20	0.60 ± 0.10	4
ERJ8EN (1206)	3.20 ± 0.05 -0.20	1.60 ± 0.05 -0.15	0.50 ± 0.20	0.50 ± 0.20	0.60 ± 0.10	10
ERJ14N (1210)	3.20 ± 0.20	2.50 ± 0.20	0.50 ± 0.20	0.50 ± 0.20	0.60 ± 0.10	16
ERJ12N (1812)	4.50 ± 0.20	3.20 ± 0.20	0.50 ± 0.20	0.50 ± 0.20	0.60 ± 0.10	27
ERJ12S (2010)	5.00 ± 0.20	2.50 ± 0.20	0.60 ± 0.20	0.60 ± 0.20	0.60 ± 0.10	27
ERJ1TN (2512)	6.40 ± 0.20	3.20 ± 0.20	0.65 ± 0.20	0.60 ± 0.20	0.60 ± 0.10	45

■ Ratings

<±0.5 %>

Type (inches)	Power Rating at 70 °C (W)	Limiting Element Voltage (Maximum RCWV) ⁽¹⁾ (V)	Maximum Overload Voltage ⁽²⁾ (V)	Resistance Tolerance (%)	Resistance Range (Ω)	T.C.R. [×10 ⁻⁶ /°C (ppm/°C)]	Category Temperature Range (Operating Temperature Range) (°C)
ERJ1RH (0201)	0.05	15	30	±0.5	1 k to 100 k (E24, E96)	±50	-55 to +125
ERJ1RK (0201)	0.05	15	30	±0.5	100 to 976 (E24, E96)	±100	-55 to +125
ERJ2RH (0402)	0.063	50	100	±0.5	100 to 100 k (E24, E96)	±50	-55 to +125
ERJ2RK (0402)	0.063	50	100	±0.5	10 to 97.6 102 k to 1 M (E24, E96)	±100	-55 to +125
ERJ3RB (0603)	0.063	50	100	±0.5	100 to 100 k (E24, E96)	±50	-55 to +125
ERJ3RE (0603)	0.063	50	100	±0.5	10 to 97.6 102 k to 1 M (E24, E96)	±100	-55 to +125
ERJ6RB (0805)	0.1	150	200	±0.5	100 to 100 k (E24, E96)	±50	-55 to +125
ERJ6RE (0805)	0.1	150	200	±0.5	10 to 97.6 102 k to 1 M (E24, E96)	±100	-55 to +125

<±1 %>

Type (inches)	Power Rating at 70 °C (W)	Limiting Element Voltage (Maximum RCWV) ⁽¹⁾ (V)	Maximum Overload Voltage ⁽²⁾ (V)	Resistance Tolerance (%)	Resistance Range (Ω)	T.C.R. [×10 ⁻⁶ /°C (ppm/°C)]	Category Temperature Range (Operating Temperature Range) (°C)
ERJXG (01005)	0.031	15	30	±1	10 to 1 M (E24, E96)	<100 Ω : ±300 100 Ω ≤ : ±200	-55 to +125
ERJ1G (0201)	0.05	25	50	±1	10 to 1 M ⁽³⁾ (E24, E96)	±200	-55 to +125
ERJ2RK (0402)	0.1	50	100	±1	10 to 1 M (E24, E96)	±100	-55 to +155
ERJ3EK (0603)	0.1	75	150	±1	10 to 1 M (E24, E96)	±100	-55 to +155
ERJ6EN (0805)	0.125	150	200	±1	10 to 2.2 M (E24, E96)	±100	-55 to +155
ERJ8EN (1206)	0.25	200	400	±1	10 to 2.2 M (E24, E96)	±100	-55 to +155
ERJ14N (1210)	0.5	200	400	±1	10 to 1 M (E24, E96)	±100	-55 to +155
ERJ12N (1812)	0.75	200	500	±1	10 to 1 M (E24, E96)	±100	-55 to +155
ERJ12S (2010)	0.75	200	500	±1	10 to 1 M (E24, E96)	±100	-55 to +155
ERJ1TN (2512)	1	200	500	±1	10 to 1 M (E24, E96)	±100	-55 to +155

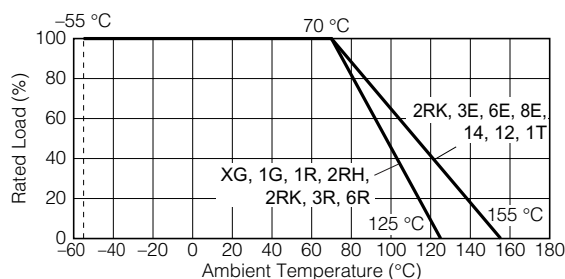
(1) Rated Continuous Working Voltage (RCWV) shall be determined from $RCWV = \sqrt{\text{Power Rating} \times \text{Resistance Values}}$, or Limiting Element Voltage (max. RCWV) listed above, whichever less.

(2) Overload (Short-time Overload) Test Voltage (SOTV) shall be determined from $SOTV = 2.5 \times \text{Power Rating}$ or max. Overload Voltage listed above whichever less.

(3) Please contact us when you need a type with a resistance of less than 10 Ω.

Power Derating Curve

For resistors operated in ambient temperatures above 70 °C, power rating shall be derated in accordance with the figure on the right.



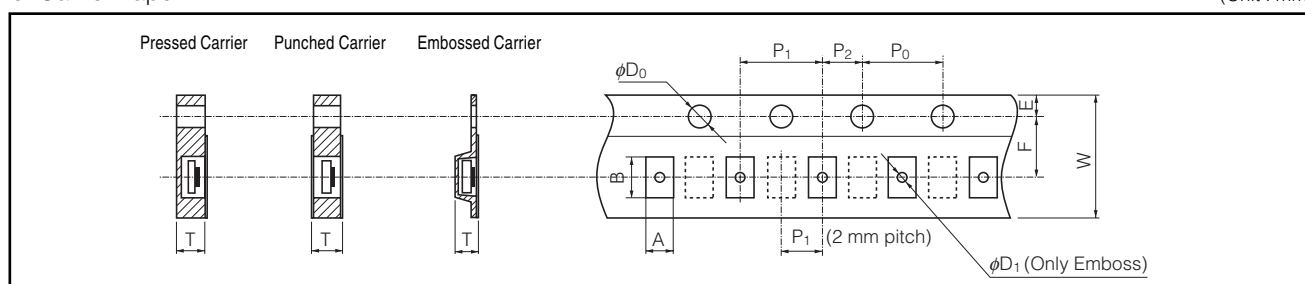
■ Packaging Methods (Taping)

● Standard Quantity

Type	Kind of Taping	Pitch (P ₁)	Quantity
ERJXG	Pressed Carrier Taping	2 mm	20000 pcs./reel
ERJ1G, ERJ1R			15000 pcs./reel
ERJ2RH, ERJ2RK			10000 pcs./reel
ERJ3R□, ERJ3EK	Punched Carrier Taping	4 mm	5000 pcs./reel
ERJ6R□, ERJ6EN			
ERJ8EN			
ERJ14N	Embossed Carrier Taping	4 mm	4000 pcs./reel
ERJ12N			
ERJ12S			
ERJ1TN			

● Carrier Tape

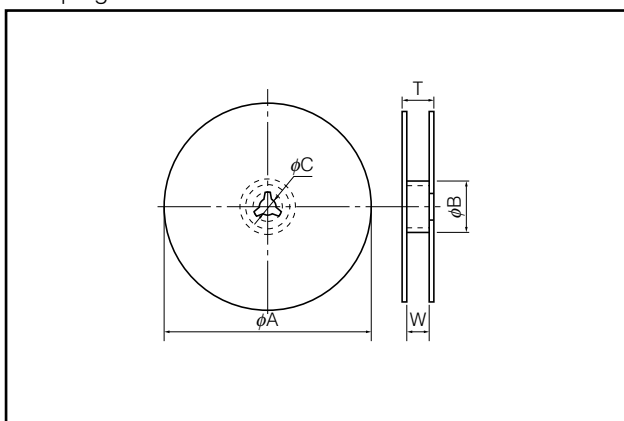
(Unit : mm)



Type	A	B	W	F	E	P ₁	P ₂	P ₀	φD ₀	T	φD ₁
ERJXG	0.24±0.03	0.45±0.03	8.00±0.20	3.50±0.05	1.75±0.10	2.00±0.10	2.00±0.05	4.00±0.10	1.50±0.10	0.31±0.05	—
ERJ1G, ERJ1R	0.38±0.05	0.68±0.05				2.00±0.10				0.42±0.05	—
ERJ2RH, ERJ2RK	0.67±0.05	1.17±0.05				2.00±0.10				0.52±0.05	—
ERJ3R□, ERJ3EK	1.10±0.10	1.90±0.10				2.00±0.10				0.70±0.05	—
ERJ6R□, ERJ6EN	1.65±0.15	2.50±0.20				2.00±0.10				0.84±0.05	—
ERJ8EN	2.00±0.15	3.60±0.20	8.00±0.30	5.50±0.20	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	1.50±0.10	0.84±0.05	—
ERJ14N	2.80±0.20	3.50±0.20								1.00±0.10	1.0±0.10
ERJ12N	3.50±0.20	4.80±0.20								1.00±0.10	1.5 min.
ERJ12S	2.80±0.20	5.30±0.20								1.00±0.10	1.5 min.
ERJ1TN	3.60±0.20	6.90±0.20	12.00±0.30	5.50±0.20	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	1.50±0.10	1.00±0.10	1.5 min.

● Taping Reel

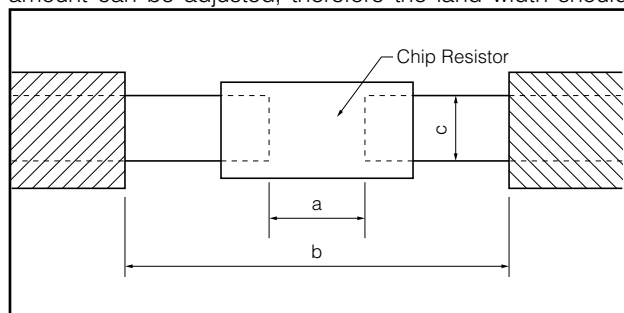
(Unit : mm)



Type	φA	φB	φC	W	T
ERJXG	180.0±3.0	60 min.	13.0±1.0	9.0±1.0	11.4±1.0
ERJ1G, ERJ1R					
ERJ2RH, ERJ2RK					
ERJ3R□, ERJ3EK					
ERJ6R□, ERJ6EN					
ERJ8EN					
ERJ14N				13.0±1.0	15.4±2.0
ERJ12N					
ERJ12S					
ERJ1TN				13.0±1.0	15.4±2.0

■ Recommended Land Pattern

In case of flow soldering, the land width must be smaller than the Chip Resistor width to control the solder amount properly. Generally, the land width should be 0.7 to 0.8 times (W) of the width of chip resistor. In case of reflow soldering, solder amount can be adjusted, therefore the land width should be set to 1.0 to 1.3 times chip resistor width (W).



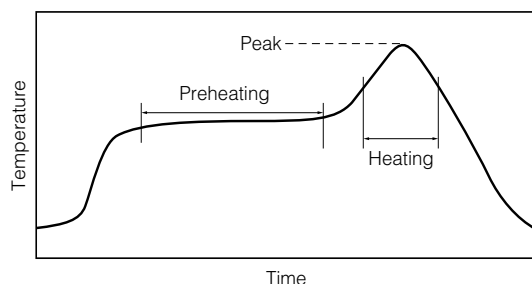
Type (inches)	Dimensions (mm)		
	a	b	c
ERJXG (01005)	0.15 to 0.2	0.5 to 0.7	0.20 to 0.25
ERJ1G, 1R (0201)	0.3 to 0.4	0.8 to 0.9	0.25 to 0.35
ERJ2R (0402)	0.5 to 0.6	1.4 to 1.6	0.4 to 0.6
ERJ3R, 3EK (0603)	0.7 to 0.9	2 to 2.2	0.8 to 1
ERJ6R, 6EN (0805)	1 to 1.4	3.2 to 3.8	0.9 to 1.4
ERJ8EN (1206)	2 to 2.4	4.4 to 5	1.2 to 1.8
ERJ14N (1210)	2 to 2.4	4.4 to 5	1.8 to 2.8
ERJ12N (1812)	3.3 to 3.7	5.7 to 6.5	2.3 to 3.5
ERJ12S (2010)	3.6 to 4	6.2 to 7	1.8 to 2.8
ERJ1TN (2512)	5 to 5.4	7.6 to 8.6	2.3 to 3.5

■ Recommended Soldering Conditions

Recommendations and precautions are described below.

● Recommended soldering conditions for reflow

- Reflow soldering shall be performed a maximum of two times.
- Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



For soldering (Example : Sn/Pb)

	Temperature	Time
Preheating	140 °C to 160 °C	60 s to 120 s
Main heating	Above 200 °C	30 s to 40 s
Peak	235 ± 5 °C	max. 10 s

For lead-free soldering (Example : Sn/Ag/Cu)

	Temperature	Time
Preheating	150 °C to 180 °C	60 s to 120 s
Main heating	Above 230 °C	30 s to 40 s
Peak	max. 260 °C	max. 10 s

● Recommended soldering conditions for flow

	For soldering		For lead-free soldering	
	Temperature	Time	Temperature	Time
Preheating	140 °C to 180 °C	60 s to 120 s	150 °C to 180 °C	60 s to 120 s
Soldering	245 ± 5 °C	20 s to 30 s	max. 260 °C	max. 10 s

⚠ Safety Precautions

The following are precautions for individual products. Please also refer to the precautions common to Fixed Resistors shown on page ER2 of this catalog.

1. Take measures against mechanical stress during and after mounting of Precision Thick Film Chip Resistors (hereafter called the resistors) so as not to damage their electrodes and protective coatings.
2. If a transient load (heavy load in a short time) like a pulse is expected to be applied, check and evaluate the operations of the resistors when installed in your products before use.
Never exceed the rated power. Otherwise, the performance and/or reliability of the resistors may be impaired.
3. Do not use halogen-based or other high-activity flux. Otherwise, the residue may impair the resistors' performance and/or reliability.
4. When soldering with a soldering iron, never touch the resistors' bodies with the tip of the soldering iron. When using a soldering iron with a high temperature tip, finish soldering as quickly as possible (within three seconds at 350 °C max.).
5. As the amount of applied solder becomes larger, the mechanical stress applied to the resistors increases, causing problems such as cracks and faulty characteristics. Avoid applying an excessive amount of solder.
6. Do not apply shock to the resistors or pinch them with a hard tool (e.g. pliers and tweezers). Otherwise, the resistors' protective coatings and bodies may be chipped, affecting their performance.
7. Avoid excessive bending of printed circuit boards in order to protect the resistors from abnormal stress.